TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type

# SSM6J402TU

- DC/DC Converter Application
- High-Speed Switching Applications

• 4.0 V drive

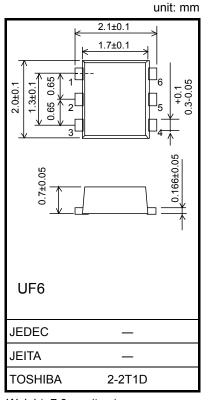
• Low ON-resistance :  $R_{DS(ON)}$  = 225m $\Omega$  max (@V<sub>GS</sub> = -4 V) :  $R_{DS(ON)}$  = 117m $\Omega$  max (@V<sub>GS</sub> = -10 V)

# Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	-30	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC	I <sub>D</sub>	-2.0	Α	
	Pulse	I <sub>DP</sub>	-4.0		
Drain power dissipation		P <sub>D</sub> (注 1)	500	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature		T <sub>stg</sub>	-55 to 150	°C	

Note 1: Mounted on an FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2)$ 



#### Weight: 7.0 mg (typ.)

# **Electrical Characteristics (Ta = 25°C)**

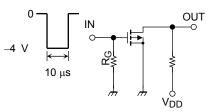
Chai	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain, source breakdown voltage	V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	V	
Drain–source breakdown voltage		V (BR) DSX	$I_D = -1 \text{ mA}, V_{GS} = 20 \text{ V}$	-15	_		_
Drain cutoff currer	nt	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-1	μА
Gate leakage curr	ent	I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μА
Gate threshold vo	Itage	V <sub>th</sub>	$V_{DS} = -5 \text{ V}, I_D = -1 \text{ mA}$	-1.2	_	-2.6	V
Forward transfer a	admittance	Y <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_D = -1 \text{ A}$ (Note2)	1.6	3.1	_	S
Drain-source ON-resistance		R <sub>DS</sub> (ON)	$I_D = -1 \text{ A}, V_{GS} = -10 \text{ V}$ (Note2)	_	80	117	- mΩ
			$I_D = -0.5 \text{ A}, V_{GS} = -4 \text{ V}$ (Note2)	_	160	225	
Input capacitance		C <sub>iss</sub>		_	280	_	
Output capacitance		Coss	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	80	_	pF
Reverse transfer	capacitance	C <sub>rss</sub>	C <sub>rss</sub>		45	_	
Total Gate Charge Gate-Source Charge		Qg	V 45V L 00A	_	5.3	_	nC
		Q <sub>gs</sub>	$V_{DS} = -15V, I_{D} = -2.0 \text{ A}$	_	4.1	_	
Gate-Drain Charge		Q <sub>gd</sub>	- V <sub>GS</sub> = −10 V	_	1.2	_	
Switching time	Turn-on time	t <sub>on</sub>	V <sub>DD</sub> = -15 V, I <sub>D</sub> = -1 A	_	16	_	ns
	Turn-off time	t <sub>off</sub>	$V_{GS} = 0$ to $-4$ V, $R_{G} = 10 \Omega$	_	35	_	
Drain-source forward voltage		V <sub>DSF</sub>	$I_D = 2 \text{ A}, V_{GS} = 0 \text{ V}$ (Note2)	_	0.8	1.2	V

Note 2: Pulse test

Start of commercial production 2008-01

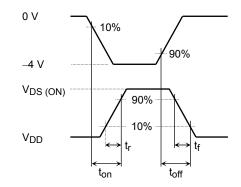
# **Switching Time Test Circuit**

# (a) Test Circuit

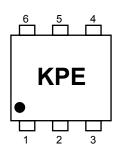


$$\begin{split} &V_{DD} = -15 \text{ V} \\ &R_G = 10 \text{ }\Omega \\ &\text{Duty} \leq 1\% \\ &V_{IN} : t_r, \ t_f < 5 \text{ ns} \\ &\text{Common Source} \end{split}$$

(b) V<sub>IN</sub>

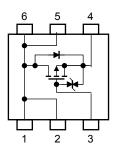


# Marking



# **Equivalent Circuit (top view)**

(c) Vout



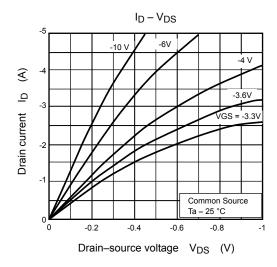
# **Notice on Usage**

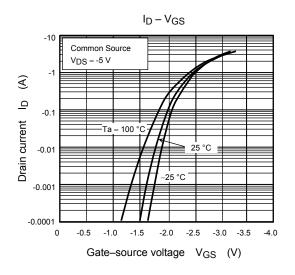
 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D$  = 1 mA for this product. For normal switching operation,  $V_{GS}$  (on) requires a higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires a lower voltage than  $V_{th}$ . (The relationship can be established as follows:  $V_{GS}$  (off) <  $V_{th}$  <  $V_{GS}$  (on).)

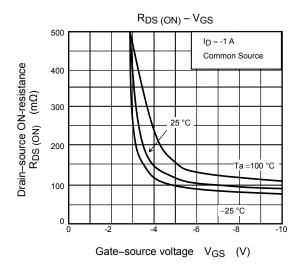
Take this into consideration when using the device.

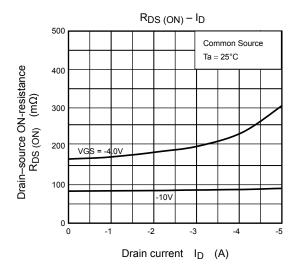
# **Handling Precaution**

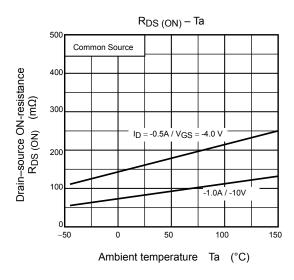
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

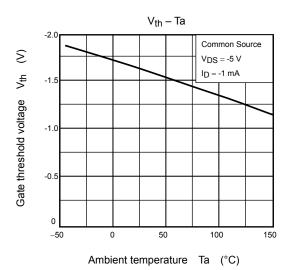




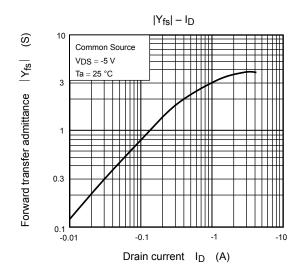


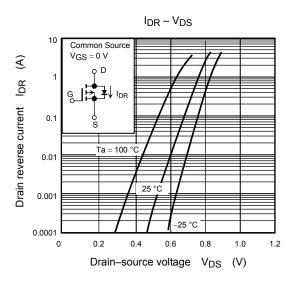


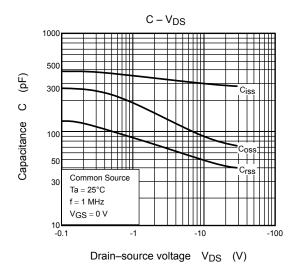


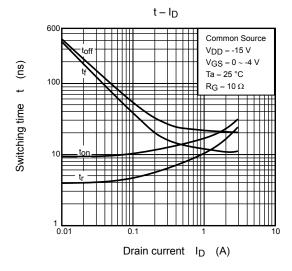


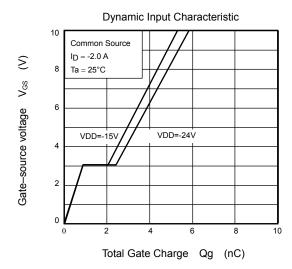
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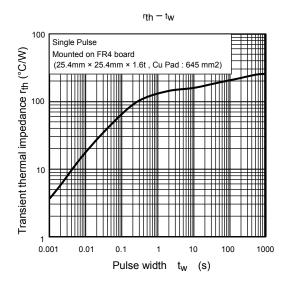


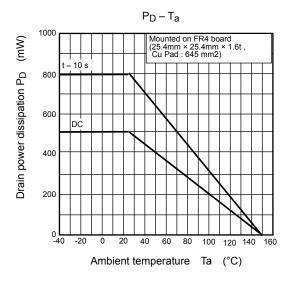












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